BE BOLD

2022 INORGANIC VENTURES WEBINAR SERIES

A SYNOPSIS OF ICP Washout Techniques

THURSDAY, JANUARY 20 9:00-9:30AM EST



PRESENTED BY:

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Key Topics

- Causes for washout issues
- Introduction system components
- Elements of concern
- Common rinse solutions / strategies
- Maintenance recommendations



Causes for washout issues

- Solution matrix (HNO₃/HCI/HF/NH₄OH)
 - Could be from commercially available standards
 - Could be from specific sample preparation protocols
- Specific elemental affinity toward different types of plastics (Pump tubing, HF-resistant intro system)
- Spray chamber design (Single-pass, double-pass)
- Rinse protocols using the wrong acids/bases
- Rinse times are not long enough

Solution Matrix

- Most elements are stable using only HNO₃
- Some elements require HF for stability
 - HF stability often revolves around plastic surfaces
 - Some elements will precipitate in the presence of HF
- Some elements require HCl for stability
 - Only a few elements have issues in the presence of HCl
- Bromide/Iodide require basic matrices for stability
 - Some other elements are stable in basic pH

Solution Matrix - HF

| Н | | | Not | Checl | ked by | y ICP | HF | Ele | mer | nts | | | | | | | | Не |
|----|----|----|-----|-------|--------|-------|----|------|------|-----|----|----|----|----|----|----|----|----|
| Li | Be | | НЕ | "th | ieve | es" | A | Avoi | d HI | = | | | В | С | Z | 0 | F | Ne |
| Na | Mg | | | | | | | | | | | | Al | Si | Р | S | Cl | Ar |
| K | Ca | | Sc | Ti | V | Cr | Mn | Fe | Со | Ni | Cu | Zn | Ga | Ge | As | Se | Br | Kr |
| Rb | Sr | | Υ | Zr | Nb | Мо | Тс | Ru | Rh | Pd | Ag | Cd | In | Sn | Sb | Te | ı | Xe |
| Cs | Ва | * | Lu | Hf | Та | W | Re | Os | Ir | Pt | Au | Hg | TI | Pb | Bi | Ро | At | Rn |
| Fr | Ra | ** | Lr | Rf | Db | Sg | Bh | Hs | Mt | Ds | Rg | Cn | Nh | Fl | Mc | Lv | Ts | Og |

| * | La | Ce | Pr | Nd | Pm | Sm | Eu | Gd | Tb | Dy | Но | Er | Tm | Yb |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| ** | Ac | Th | Pa | U | Np | Pu | Am | Cm | Bk | Cf | Es | Fm | Md | No |

Solution Matrix - HCl

| Н | | | Not | Checl | ked by | y ICP | НС | l Ele | eme | nts | | | | | | | | Не |
|----|----|----|-----|-------|--------|-------|----|-------|------|-----|----|----|----|----|----|----|----|----|
| Li | Be | | Can | wor | k w/o | o HF | Д | voi | d HC | | | | В | С | Z | 0 | H | Ne |
| Na | Mg | | | | | | | | | | | | Al | Si | Р | S | Cl | Ar |
| K | Ca | | Sc | Ti | V | Cr | Mn | Fe | Со | Ni | Cu | Zn | Ga | Ge | As | Se | Br | Kr |
| Rb | Sr | | Υ | Zr | Nb | Мо | Тс | Ru | Rh | Pd | Ag | Cd | In | Sn | Sb | Te | ı | Xe |
| Cs | Ва | * | Lu | Hf | Та | W | Re | Os | Ir | Pt | Au | Hg | TI | Pb | Bi | Ро | At | Rn |
| Fr | Ra | ** | Lr | Rf | Db | Sg | Bh | Hs | Mt | Ds | Rg | Cn | Nh | Fl | Mc | Lv | Ts | Og |

| * | La | Ce | Pr | Nd | Pm | Sm | Eu | Gd | Tb | Dy | Но | Er | Tm | Yb |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| ** | Ac | Th | Pa | U | Np | Pu | Am | Cm | Bk | Cf | Es | Fm | Md | No |

Solution Matrix – TEA/NH₄OH/H₂O

| Н | | | Not | Checl | ked by | y ICP | Bas | ic El | eme | ents | | | | | | | | Не |
|----|----|----|-----|-------|--------|--------------------|--------|-------|---------|-------|----|----|----|----|----|----|----|----|
| Li | Be | | Can | work | w/o H | INO ₃ / | HF, bι | ıt mu | st be l | oasic | | | В | C | Z | 0 | F | Ne |
| Na | Mg | | | | | | | | | | | | Al | Si | Р | S | Cl | Ar |
| K | Ca | | Sc | Ti | V | Cr | Mn | Fe | Со | Ni | Cu | Zn | Ga | Ge | As | Se | Br | Kr |
| Rb | Sr | | Υ | Zr | Nb | Мо | Тс | Ru | Rh | Pd | Ag | Cd | In | Sn | Sb | Те | 1 | Xe |
| Cs | Ва | * | Lu | Hf | Та | W | Re | Os | Ir | Pt | Au | Hg | TI | Pb | Bi | Ро | At | Rn |
| Fr | Ra | ** | Lr | Rf | Db | Sg | Bh | Hs | Mt | Ds | Rg | Cn | Nh | Fl | Мс | Lv | Ts | Og |

| * | La | Ce | Pr | Nd | Pm | Sm | Eu | Gd | Tb | Dy | Но | Er | Tm | Yb |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| ** | Ac | Th | Pa | U | Np | Pu | Am | Cm | Bk | Cf | Es | Fm | Md | No |

Key Topics

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- Introduction system components
- Elements of concern
- Common rinse solutions / strategies
- Maintenance recommendations



Spray Chambers

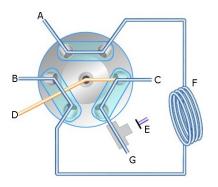
- Classical borosilicate glass
 - If HF is used, problems testing B and Si
 - B and Si will leach out of the spray chamber
- HF Resistant Systems (PTFE/PFA)
 - If high levels are run, B, Si, and Hg can stick around
 - No leaching of B and Si from the material
 - Coating is essential to help with performance
- Double pass spray chambers increase washout time significantly



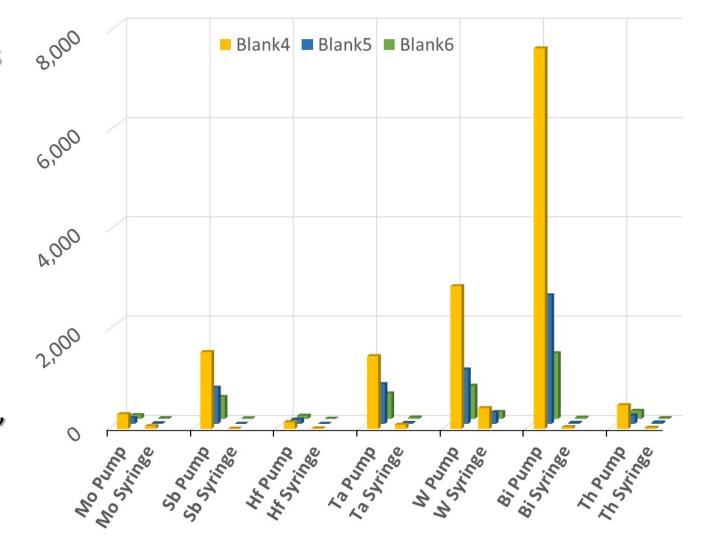
Sample Delivery

- Peristaltic Pump
 - Sample is introduced from autosampler probe through peristaltic pump tubing before it reaches the nebulizer
 - Many elements stick to the PVC peristaltic pump tubing
- Syringe Drive / Switching Valve Systems
 - Sample is loaded into a sample loop without passing through peristaltic pump tubing
 - PVC tubing is eliminated, but a switching valve is added to the equation





- Washout of select "sticky" elements after a 4ppb spike containing over 60 elements.
- Bi is by far the worst.
- PVC tubing is used for peri-pump introduction systems.
- Faster washout of elements using syringe drive systems allows us to run more samples free of "memory" interferences.
- This results in less maintenance when running high TDS samples.



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Problem Elements

| Н | | | Not | Checl | ked by | y ICP | Elemen | ts with | washou | t issues | | | | | | | | Не |
|----|----|----|-----|-------|--------|-------|--------|---------|--------|----------|----|----|----|----|----|----|----|----|
| Li | Be | | | | | | | | | | | | В | С | N | 0 | F | Ne |
| Na | Mg | | | | | | | | | | | | Al | Si | Р | S | Cl | Ar |
| K | Ca | | Sc | Ti | V | Cr | Mn | Fe | Со | Ni | Cu | Zn | Ga | Ge | As | Se | Br | Kr |
| Rb | Sr | | Υ | Zr | Nb | Мо | Тс | Ru | Rh | Pd | Ag | Cd | In | Sn | Sb | Te | ı | Xe |
| Cs | Ва | * | Lu | Hf | Та | W | Re | Os | Ir | Pt | Au | Hg | TI | Pb | Bi | Ро | At | Rn |
| Fr | Ra | ** | Lr | Rf | Db | Sg | Bh | Hs | Mt | Ds | Rg | Cn | Nh | Fl | Мс | Lv | Ts | Og |

| * | La | Ce | Pr | Nd | Pm | Sm | Eu | Gd | Tb | Dy | Но | Er | Tm | Yb |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| ** | Ac | Th | Pa | J | Np | Pu | Am | Cm | Bk | Cf | Es | Fm | Md | No |

Why?

| Н | | | Not s | sure, P | VC tu | bing? | HNO | ₃ mak | es it s | ticky | | | | | | | | Не |
|----|----|----|--------|---------|---------|--------|-------|---------|----------------------|--------|----|----|----|----|----|----|----|----|
| Li | Be | | Lack o | of HF m | akes it | sticky | HCl m | iakes i | t preci _l | pitate | | | В | C | N | 0 | F | Ne |
| Na | Mg | | | | | | | | | | | | Al | Si | Р | S | C | Ar |
| K | Ca | | Sc | Ti | V | Cr | Mn | Fe | Со | Ni | Cu | Zn | Ga | Ge | As | Se | Br | Kr |
| Rb | Sr | | Υ | Zr | Nb | Mo | Тс | Ru | Rh | Pd | Ag | Cd | In | Sn | Sb | Te | _ | Xe |
| Cs | Ba | * | Lu | Hf | Та | W | Re | Os | Ir | Pt | Au | Hg | TI | Pb | Bi | Ро | At | Rn |
| Fr | Ra | ** | Lr | Rf | Db | Sg | Bh | Hs | Mt | Ds | Rg | Cn | Nh | Fl | Мс | Lv | Ts | Og |

| * | La | Ce | Pr | Nd | Pm | Sm | Eu | Gd | Tb | Dy | Но | Er | Tm | Yb |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| ** | Ac | Th | Pa | U | Np | Pu | Am | Cm | Bk | Cf | Es | Fm | Md | No |

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Common Rinse Solutions

• HNO₃

- 5-10% on an OES
- 1-2% on a MS
- HCl
 - 5-10% on an OES
 - 1-2% on a MS

- RBS-25
 - 2.5% on an OES
 - Not Recommended on MS due to high Sodium
- H₂O
 - Can be effective enough for Na, K, Ca, etc.

Rinse Solutions with HF

- HNO₃
 - 5-10% on an OES
 - 1-2% on a MS
- HF
 - 0.1-2% on an OES
 - 0.05-0.5% on a MS

 If using borosilicate glass nebulizer and spray chamber



- Limit HF to a max of 0.2%
- B and Si results will be unreliable
- If using an HF resistant nebulizer and spray chamber



- Can go up to 2-3%
- >3% HF degrades the coating

Specialty Rinse Solutions

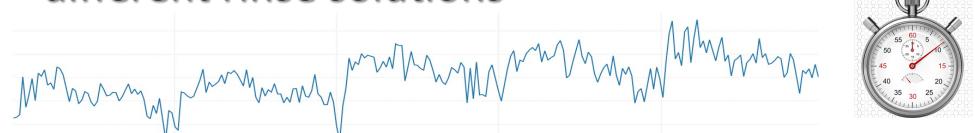
- NH₄OH
 - 1-5% for OES or MS
 - Use for B, Br, I, Hg
- HCl / Thiourea
 - 1-10% HCl
 - 0.5% Thiourea
 - Use for Hg, Au, Os

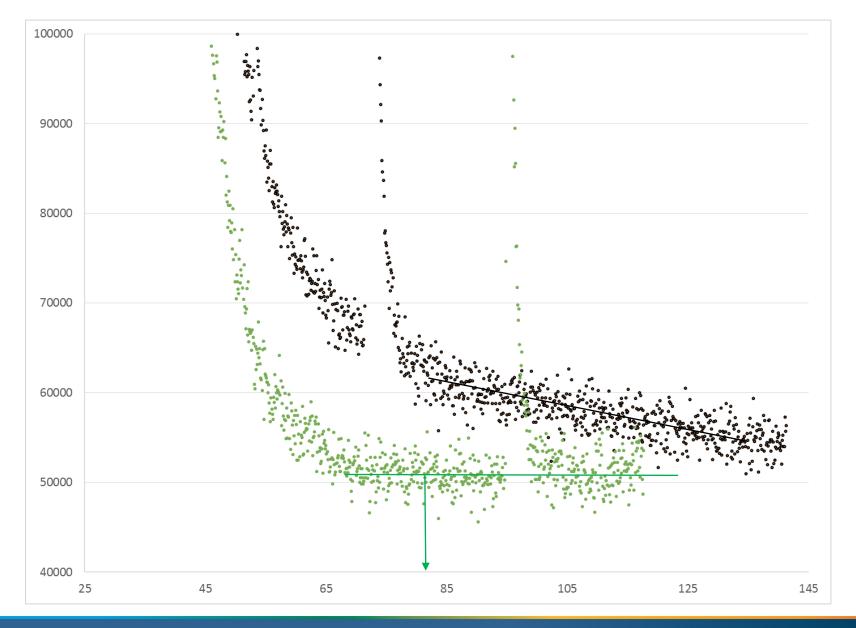
- HCl / Hydroxylamine·HCl
 - 10% HCl
 - 0.5% NH₂OH·HCl
 - Use for Os

Utilize real-time output monitoring

- Some instrument software packages allow you to monitor a line in real time and record the signal vs time
- This can help with method development activities in determining appropriate rinse times between samples

 It can also be helpful in assessing the effectiveness of different rinse solutions





Monitoring Washout on B 208.959nm

Rinse w/ 5% HNO₃

Rinse w/ 5% NH₄OH

5% HNO₃ doesn't go to baseline even within 2 minutes.

5% NH₄OH rinses it out within 80 seconds.

Experiment with different rinse strategies

- Switching valve and syringe drive systems pose an extra challenge to washout due to the use of a dedicated carrier solution.
- Most ICP-MS users prefer to use HNO₃ to prevent ⁴⁰Ar³⁵Cl⁺
 40Ar³⁷Cl⁺ from interfering on ⁷⁵As & ⁷⁷Se.
- Running rinse solutions as samples in varying order can help determine which types of rinses are more effective for certain elements and intro-system setups.

Key Topics

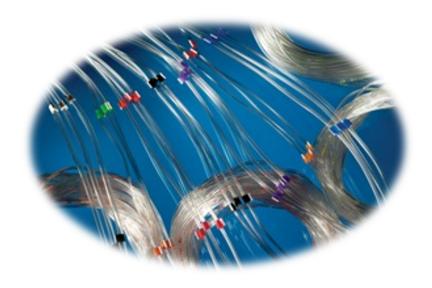
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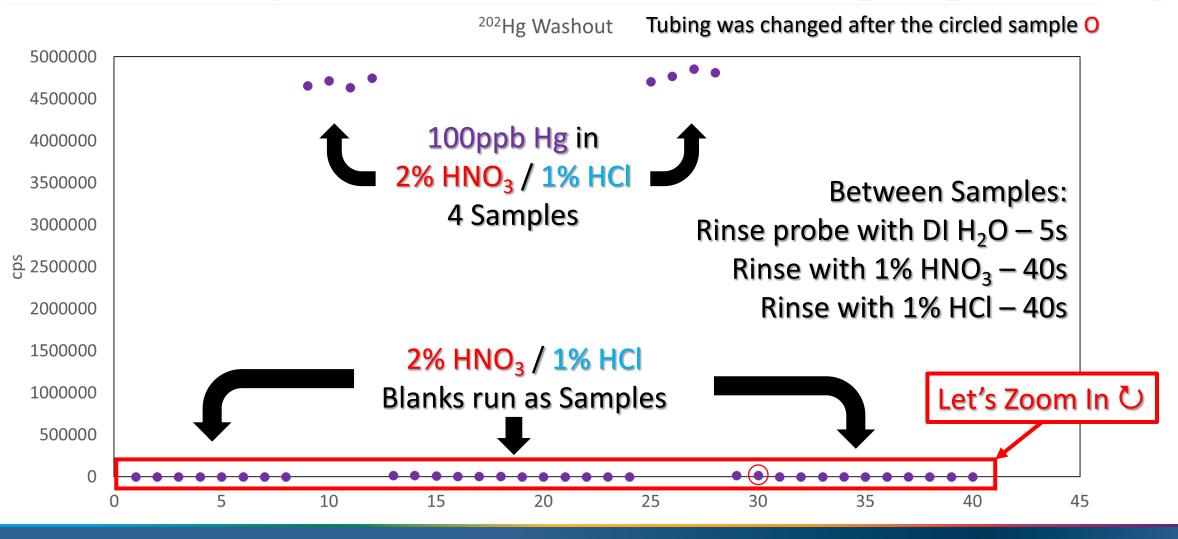
Peristaltic Pump Tubing

- If using peristaltic pump tubing for sample delivery...
 - Consider changing the tubing daily
 - Or directly after a run with "sticky" elements



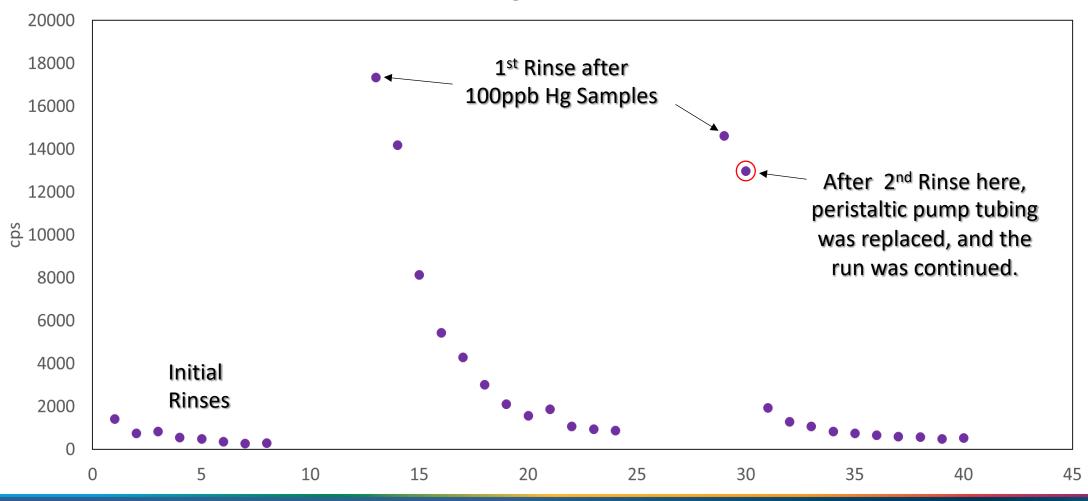


Example of effect of changing tubing



Example of effect of changing tubing

²⁰²Hg Washout

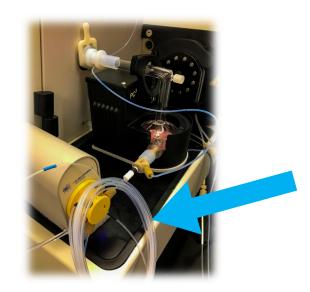


Switching Valve Systems

- Sample loops do inevitably become dirty
- When not in use, make sure carrier solution flows through the sample loop to continuously clean it
- Replacing valve sleeves can help when routine cleaning no longer helps.

Switching Valve Systems

- If using a sample loop, shaking the loop while it is rinsing can help clear out stuck elements.
- This phenomenon can be observed using real-time display



Weekly Soaking of Various Parts

Soak dirty spray chambers, nebulizers, and valve sleeves

in 25% solution of RBS-25.

• Rinse with lots of DI H₂O.



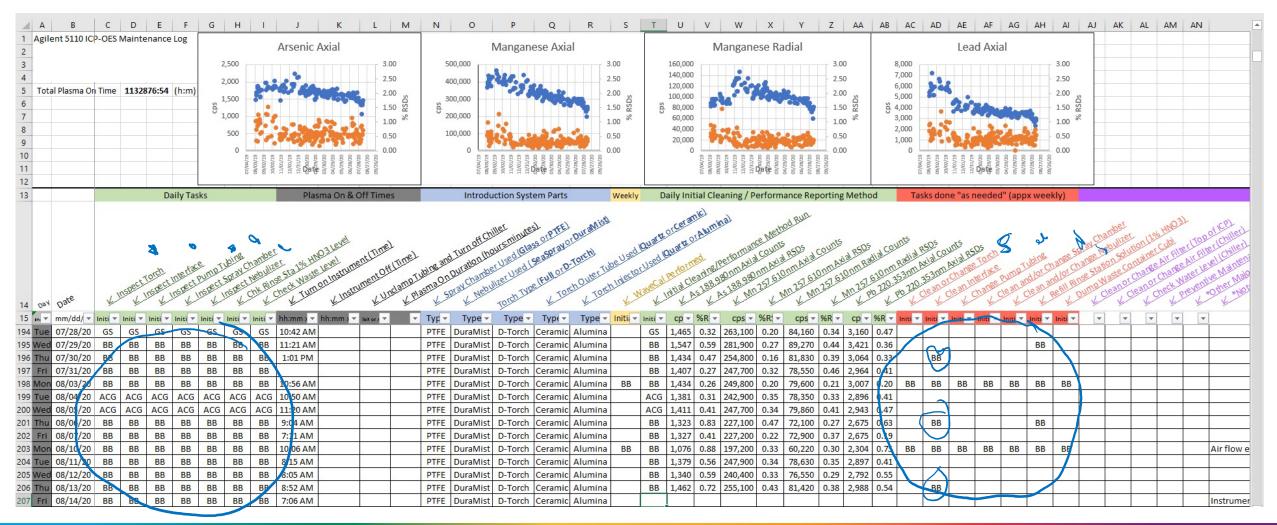




More tips and tricks for washout issues

- Keep up with routine instrument maintenance to prevent other washout issues.
 - Torch parts, cones/interface, tubing, autosampler probe, rinse station reservoirs
 - Keep a detailed log of maintenance steps and record performance report data

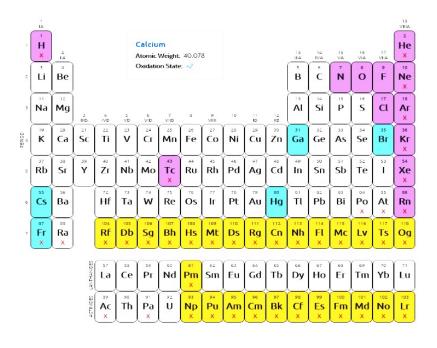
Example of a Daily Maintenance Log



Final Thoughts

- Identify the elements that give you trouble
- Experiment with different rinse solutions
- Keep up with routine instrument maintenance
- Identify specific causes for washout issues
- Develop methods that include effective rinse strategies and only the elements you require

Technical Support – Available to Everyone Online Resources at inorganicventures.com









Customers can visit our website's Tech Center, which includes:



- Interactive Periodic Table
- Sample Preparation Guide
- Trace Analysis Guide
- ICP Operations Guide
- Expert Advice
- And much, much more.



